

$V_{RSM}$	=	2800 V
$I_{F(AV)M}$	=	5380 A
$I_{F(RMS)}$	=	8450 A
$I_{FSM}$	=	$65 \times 10^3$ A
$V_{F0}$	=	0.77 V
$r_F$	=	0.082 mW

# Rectifier Diode

## 5SDD 51L2800

Doc. No. 5SYA1103-01 Feb. 05

- Patented free-floating silicon technology
- Very low on-state losses
- High average and surge current.

### Blocking

*Maximum rated values* <sup>1)</sup>

Parameter	Symbol	Conditions	Value	Unit
Repetitive peak reverse voltage	$V_{RRM}$	$f = 50$ Hz, $t_p = 10$ ms, $T_j = 175^\circ\text{C}$	2000	V
Non-repetitive peak reverse voltage	$V_{RSM}$	$f = 5$ Hz, $t_p = 10$ ms, $T_j = 175^\circ\text{C}$	2800	V
Non-repetitive peak reverse voltage	$V_{RSM}$	$f = 50$ Hz, $t_p \leq 5$ ms, $T_j = \dots 175^\circ\text{C}$	3000	V

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. (reverse) leakage current	$I_{RRM}$	$V_{RRM}$ , $T_j = 175^\circ\text{C}$			400	mA

$T_{vj} = -40^\circ\text{C}$  reduces  $V_{RSM}$  and  $V_{RRM}$  by 5%.

### Mechanical data

*Maximum rated values* <sup>1)</sup>

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	$F_M$		63	70	77	kN
Acceleration	a	Device unclamped			50	$\text{m/s}^2$
Acceleration	a	Device clamped			100	$\text{m/s}^2$

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Weight	m				1.45	kg
Housing thickness	H	$F_M = 70$ kN, $T_a = 25^\circ\text{C}$	25.7		26.3	mm
Surface creepage distance	$D_S$		35			mm
Air strike distance	$D_a$		14			mm

1) Maximum rated values indicate limits beyond which damage to the device may occur

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## On-state

Maximum rated values <sup>1)</sup>

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. average on-state current	$I_{F(AV)M}$	50 Hz, Half sine wave, $T_C = 85^\circ\text{C}$			5380	A
Max. RMS on-state current	$I_{F(RMS)}$				8450	A
Max. peak non-repetitive surge current	$I_{FSM}$	$t_p = 10\text{ ms}$ , $T_j = 175^\circ\text{C}$ , $V_R = 0\text{ V}$			$65 \times 10^3$	A
Limiting load integral	$I^2t$				$21.13 \times 10^6$	$\text{A}^2\text{s}$
Max. peak non-repetitive surge current	$I_{FSM}$	$t_p = 8.3\text{ ms}$ , $T_j = 175^\circ\text{C}$ , $V_R = 0\text{ V}$			$70 \times 10^3$	A
Limiting load integral	$I^2t$				$20.34 \times 10^6$	$\text{A}^2\text{s}$

### Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	$V_F$	$I_F = 5000\text{ A}$ , $T_j = 175^\circ\text{C}$		1.18		V
Threshold voltage	$V_{(T0)}$	$T_j = 175^\circ\text{C}$ $I_T = 2500 \dots 7500\text{ A}$			0.77	V
Slope resistance	$r_T$				0.082	$\text{m}\Omega$

## Switching

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Recovery charge	$Q_{rr}$	$di_F/dt = -10\text{ A}/\mu\text{s}$ , $V_R = 200\text{ V}$ $I_{FRM} = 4000\text{ A}$ , $T_j = 175^\circ\text{C}$			7000	$\mu\text{As}$

# Thermal

Maximum rated values <sup>1)</sup>

Parameter	Symbol	Conditions	min	typ	max	Unit
Operating junction temperature range	T <sub>vj</sub>				175	°C
Storage temperature range	T <sub>stg</sub>		-40		150	°C

## Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Thermal resistance junction to case	R <sub>th(j-c)</sub>	Double-side cooled F <sub>m</sub> = 63...77 kN			8	K/kW
	R <sub>th(j-c)A</sub>	Anode-side cooled F <sub>m</sub> = 63...77 kN			16	K/kW
	R <sub>th(j-c)C</sub>	Cathode-side cooled F <sub>m</sub> = 63...77 kN			16	K/kW
Thermal resistance case to heatsink	R <sub>th(c-h)</sub>	Double-side cooled F <sub>m</sub> = 63...77 kN			3	K/kW
	R <sub>th(c-h)</sub>	Single-side cooled F <sub>m</sub> = 63...77 kN			6	K/kW

Analytical function for transient thermal impedance:

$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_{th i} (1 - e^{-t/t_i})$$

i	1	2	3	4
R <sub>th i</sub> (K/kW)	5.364	1.586	0.638	0.412
τ <sub>i</sub> (s)	0.5339	0.0684	0.0067	0.0013

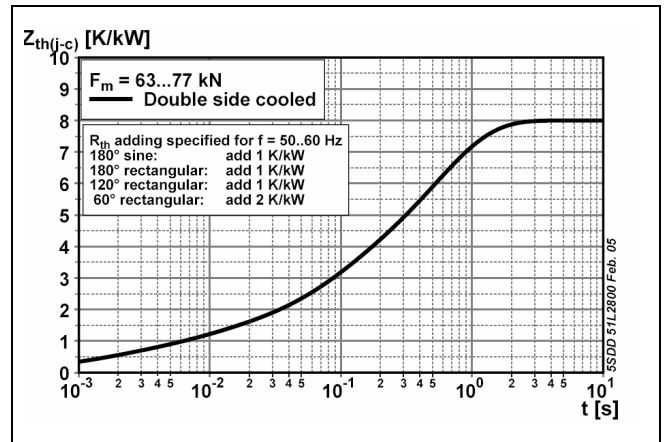


Fig. 1 Transient thermal impedance junction-to-case.

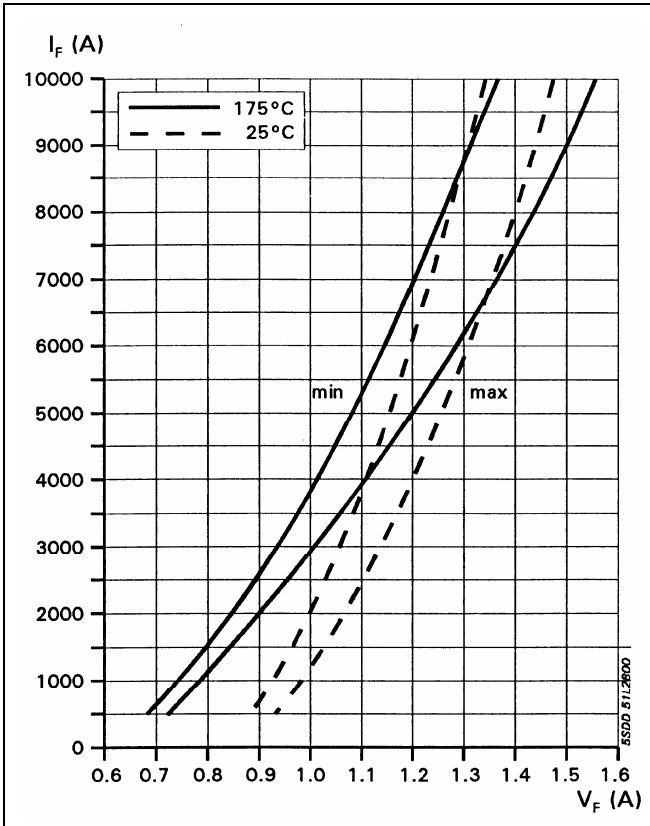


Fig. 2 On-state characteristics.

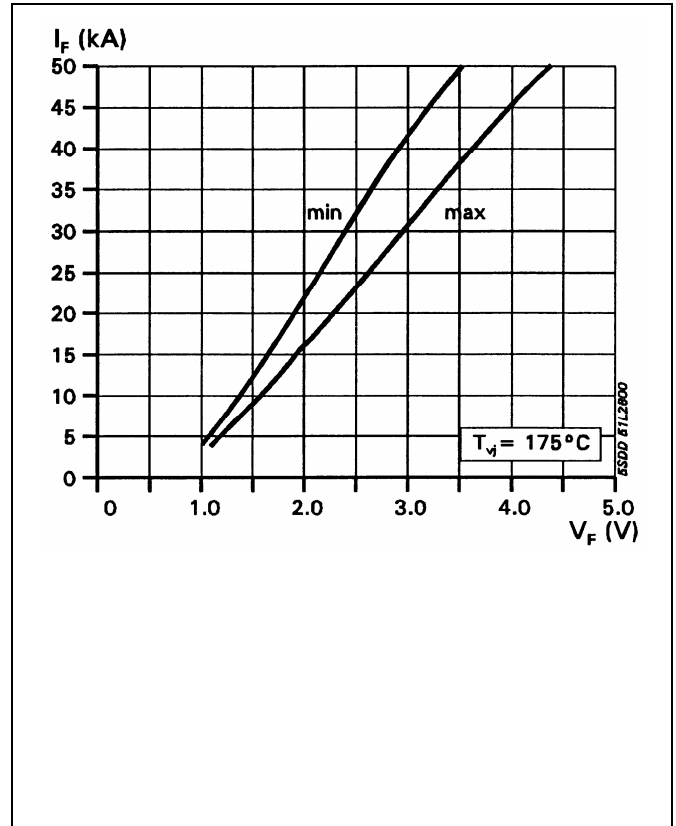


Fig. 3 On-state characteristics.

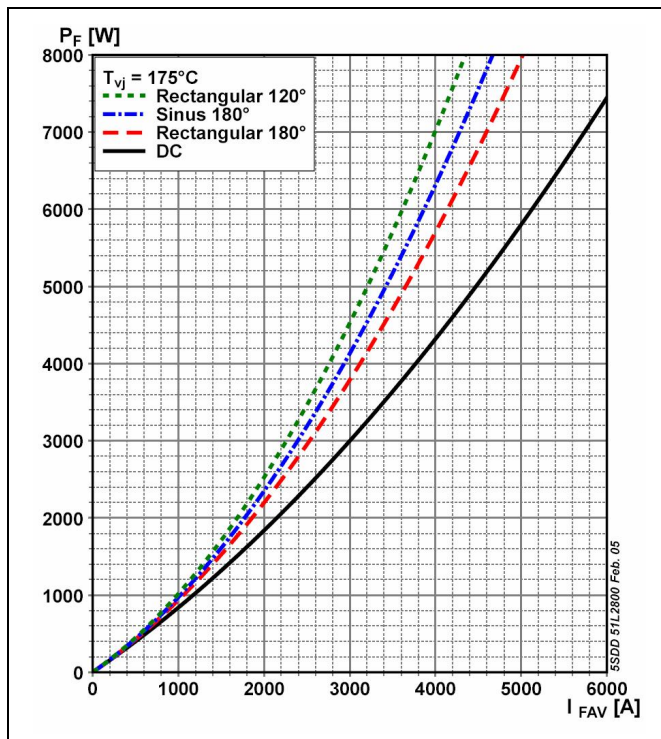


Fig. 4 On-state power losses vs average on-state current.

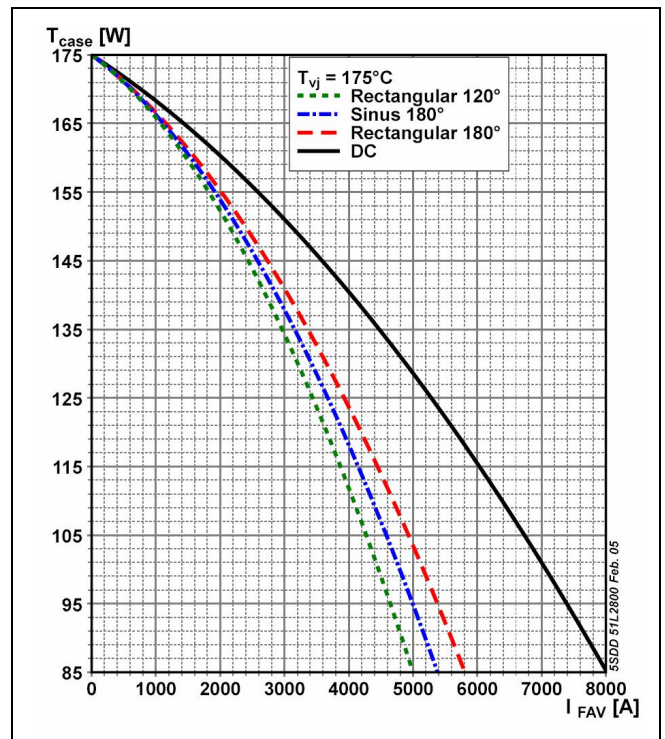


Fig. 5 Max. permissible case temperature vs average on-state current.

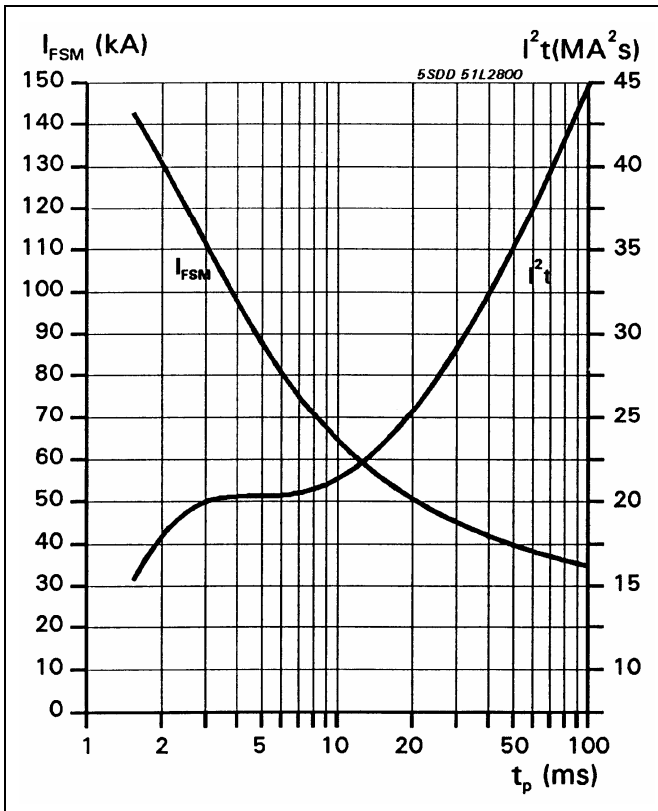


Fig. 6 Surge on-state current vs. pulse length. Half-sine wave.

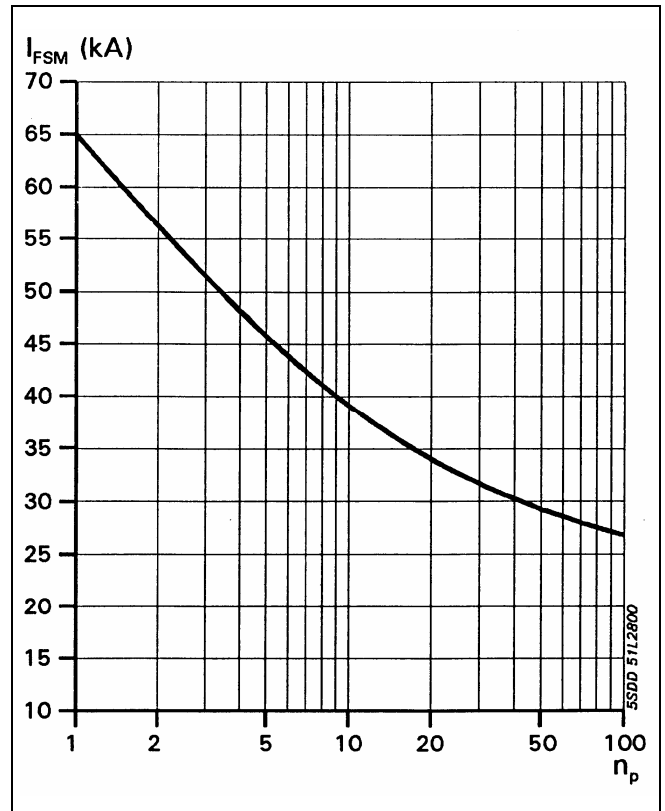


Fig. 7 Surge on-state current vs. number of pulses. Half-sine wave, 10 ms, 50Hz.

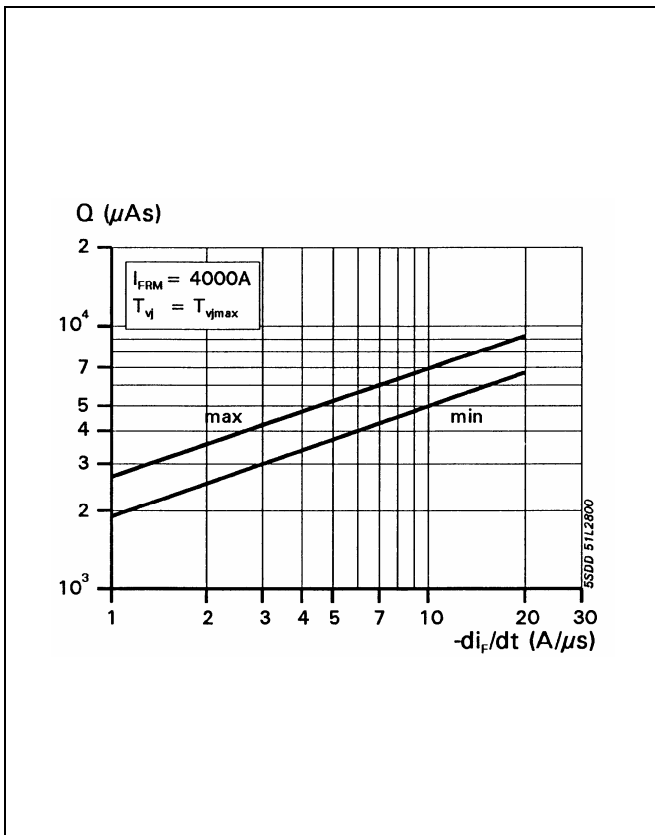
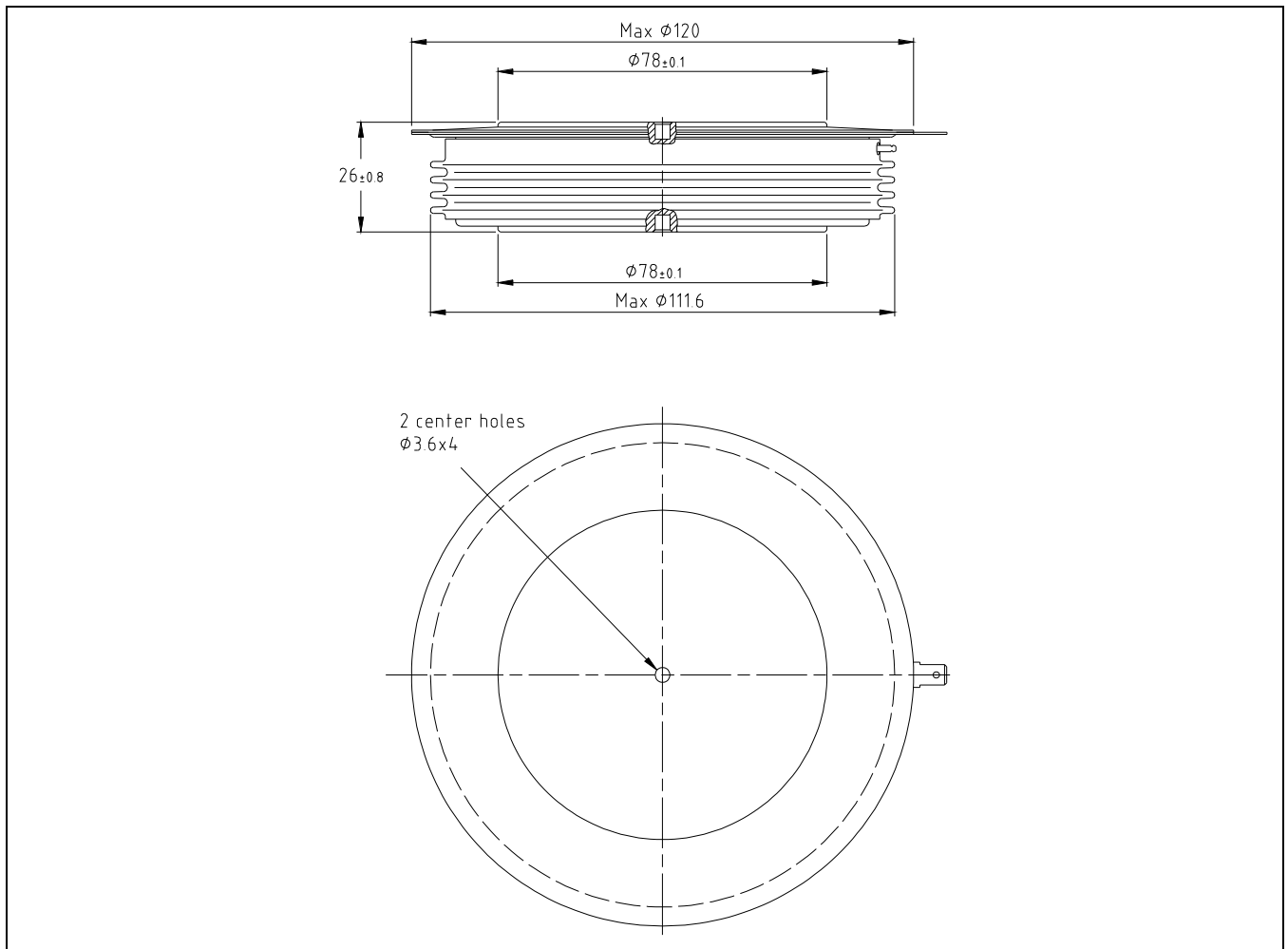


Fig. 8 Recovery charge vs. decay rate of on-state current.



**Fig. 9** Outline drawing. All dimensions are in millimeters and represent nominal values unless stated otherwise.

### Related application notes:

Doc. Nr	Titel
5SYA 2020	Design of RC-Snubbers for Phase Control Applications
5SYA 2029	Designing Large Rectifiers with High Power Diodes
5SYA 2036	Recommendations regarding mechanical clamping of Press Pack High Power Semiconductors

Please refer to <http://www.abb.com/semiconductors> for actual versions.

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Doc. No. 5SYA1103-01 Feb. 05

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